

## Trench gate field-stop IGBT, M series 650 V, 30 A low loss

Datasheet - production data

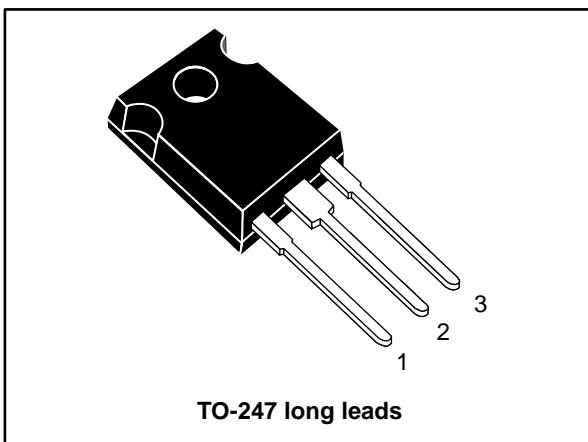
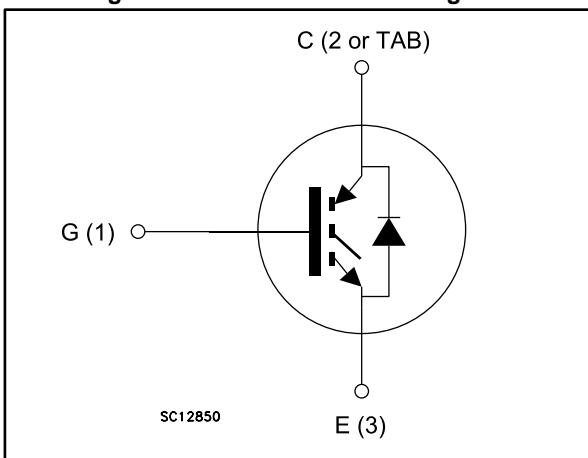


Figure 1: Internal schematic diagram



### Features

- 6  $\mu$ s of short-circuit withstand time
- $V_{CE(sat)} = 1.55$  V (typ.) @  $I_C = 30$  A
- Tight parameters distribution
- Safer paralleling
- Low thermal resistance
- Soft and very fast recovery antiparallel diode

### Applications

- Motor control
- UPS
- PFC

### Description

This device is an IGBT developed using an advanced proprietary trench gate field-stop structure. The device is part of the M series of IGBTs, which represent an optimum compromise in performance to maximize the efficiency of inverter systems where low-loss and short-circuit capability are essential. Furthermore, a positive  $V_{CE(sat)}$  temperature coefficient and tight parameter distribution result in safer paralleling operation.

Table 1: Device summary

Order code	Marking	Package	Packaging
STGWA30M65DF2	G30M65DF2	TO-247 long leads	Tube

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# 1 Electrical ratings

**Table 2: Absolute maximum ratings**

<b>Symbol</b>	<b>Parameter</b>	<b>Value</b>	<b>Unit</b>
$V_{CES}$	Collector-emitter voltage ( $V_{GE} = 0$ )	650	V
$I_C$	Continuous collector current at $T_C = 25^\circ\text{C}$	60	A
$I_C$	Continuous collector current at $T_C = 100^\circ\text{C}$	30	A
$I_{CP}^{(1)}$	Pulsed collector current	120	A
$V_{GE}$	Gate-emitter voltage	$\pm 20$	V
$I_F$	Continuous forward current at $T_C = 25^\circ\text{C}$	60	A
$I_F$	Continuous forward current at $T_C = 100^\circ\text{C}$	30	A
$I_{FP}^{(1)}$	Pulsed forward current	120	A
$P_{TOT}$	Total dissipation at $T_C = 25^\circ\text{C}$	258	W
$T_{STG}$	Storage temperature range	- 55 to 150	$^\circ\text{C}$
$T_J$	Operating junction temperature	- 55 to 175	$^\circ\text{C}$

**Notes:**

(1) Pulse width limited by maximum junction temperature.

**Table 3: Thermal data**

<b>Symbol</b>	<b>Parameter</b>	<b>Value</b>	<b>Unit</b>
$R_{thJC}$	Thermal resistance junction-case IGBT	0.58	$^\circ\text{C}/\text{W}$
$R_{thJC}$	Thermal resistance junction-case diode	1.47	$^\circ\text{C}/\text{W}$
$R_{thJA}$	Thermal resistance junction-ambient	50	$^\circ\text{C}/\text{W}$

## 2 Electrical characteristics

$T_C = 25^\circ\text{C}$  unless otherwise specified

Table 4: Static characteristics

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$V_{(BR)CES}$	Collector-emitter breakdown voltage	$V_{GE} = 0 \text{ V}, I_C = 2 \text{ mA}$	650			V
$V_{CE(\text{sat})}$	Collector-emitter saturation voltage	$V_{GE} = 15 \text{ V}, I_C = 30 \text{ A}$		1.55	2.0	V
		$V_{GE} = 15 \text{ V}, I_C = 30 \text{ A}, T_J = 125^\circ\text{C}$		1.95		
		$V_{GE} = 15 \text{ V}, I_C = 30 \text{ A}, T_J = 175^\circ\text{C}$		2.1		
$V_F$	Forward on-voltage	$I_F = 30 \text{ A}$		1.85		V
		$I_F = 30 \text{ A}, T_J = 125^\circ\text{C}$		1.6		
		$I_F = 30 \text{ A}, T_J = 175^\circ\text{C}$		1.5		
$V_{GE(\text{th})}$	Gate threshold voltage	$V_{CE} = V_{GE}, I_C = 500 \mu\text{A}$	5	6	7	V
$I_{CES}$	Collector cut-off current	$V_{GE} = 0 \text{ V}, V_{CE} = 650 \text{ V}$			25	$\mu\text{A}$
$I_{GES}$	Gate-emitter leakage current	$V_{CE} = 0 \text{ V}, V_{GE} = \pm 20 \text{ V}$			250	$\mu\text{A}$

Table 5: Dynamic characteristics

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$C_{ies}$	Input capacitance	$V_{CE} = 25 \text{ V}, f = 1 \text{ MHz}, V_{GE} = 0 \text{ V}$	-	2490	-	pF
$C_{oes}$	Output capacitance		-	143	-	
$C_{res}$	Reverse transfer capacitance		-	46	-	
$Q_g$	Total gate charge	$V_{CC} = 520 \text{ V}, I_C = 30 \text{ A}, V_{GE} = 15 \text{ V}$ (see <a href="#">Figure 30: "Gate charge test circuit"</a> )	-	80	-	nC
$Q_{ge}$	Gate-emitter charge		-	18	-	
$Q_{gc}$	Gate-collector charge		-	32	-	

Table 6: IGBT switching characteristics (inductive load)

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$t_{d(on)}$	Turn-on delay time	$V_{CE} = 400 \text{ V}, I_C = 30 \text{ A}, V_{GE} = 15 \text{ V}, R_G = 10 \Omega$ (see <i>Figure 29: "Test circuit for inductive load switching"</i> )		31.6	-	ns
$t_r$	Current rise time			13.4	-	ns
$(di/dt)_{on}$	Turn-on current slope			1791	-	A/ $\mu$ s
$t_{d(off)}$	Turn-off-delay time			115	-	ns
$t_f$	Current fall time			110	-	ns
$E_{on}^{(1)}$	Turn-on switching losses			0.3	-	mJ
$E_{off}^{(2)}$	Turn-off switching losses			0.96	-	mJ
$E_{ts}$	Total switching losses			1.26	-	mJ
$t_{d(on)}$	Turn-on delay time	$V_{CE} = 400 \text{ V}, I_C = 30 \text{ A}, V_{GE} = 15 \text{ V}, R_G = 10 \Omega$ $T_J = 175 \text{ }^\circ\text{C}$ (see <i>Figure 29: "Test circuit for inductive load switching"</i> )		30	-	ns
$t_r$	Current rise time			17	-	ns
$(di/dt)_{on}$	Turn-on current slope			1435	-	A/ $\mu$ s
$t_{d(off)}$	Turn-off-delay time			116	-	ns
$t_f$	Current fall time			194	-	ns
$E_{on}$	Turn-on switching losses			0.67	-	mJ
$E_{off}$	Turn-off switching losses			1.36	-	mJ
$E_{ts}$	Total switching losses			2.03	-	mJ
$t_{sc}$	Short-circuit withstand time	$V_{CC} \leq 400 \text{ V}, V_{GE} = 15 \text{ V}, T_{Jstart} = 150 \text{ }^\circ\text{C}$	6		-	$\mu$ s

**Notes:**

(1) Energy losses include reverse recovery of the diode.

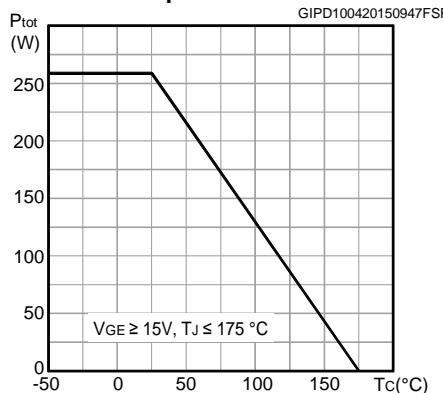
(2) Turn-off losses also include the tail of the collector current.

Table 7: Diode switching characteristics (inductive load)

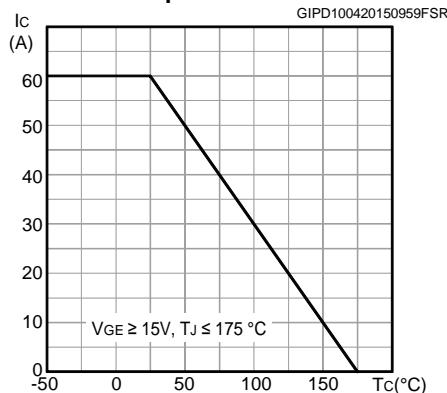
Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$t_{rr}$	Reverse recovery time	$I_F = 30 \text{ A}, V_R = 400 \text{ V}, V_{GE} = 15 \text{ V}$ (see <i>Figure 29: "Test circuit for inductive load switching"</i> ) $di/dt = 1000 \text{ A}/\mu\text{s}$	-	140		ns
$Q_{rr}$	Reverse recovery charge		-	880		nC
$I_{rrm}$	Reverse recovery current		-	17		A
$dI_{rr}/dt$	Peak rate of fall of reverse recovery current during $t_b$		-	650		A/ $\mu$ s
$E_{rr}$	Reverse recovery energy		-	115		$\mu$ J
$t_{rr}$	Reverse recovery time		-	244		ns
$Q_{rr}$	Reverse recovery charge	$I_F = 30 \text{ A}, V_R = 400 \text{ V}, V_{GE} = 15 \text{ V}$ $T_J = 175 \text{ }^\circ\text{C}$ (see <i>Figure 29: "Test circuit for inductive load switching"</i> ) $di/dt = 1000 \text{ A}/\mu\text{s}$	-	2743		nC
$I_{rrm}$	Reverse recovery current		-	25		A
$dI_{rr}/dt$	Peak rate of fall of reverse recovery current during $t_b$		-	220		A/ $\mu$ s
$E_{rr}$	Reverse recovery energy		-	320		$\mu$ J

## 2.1 Electrical characteristics (curves)

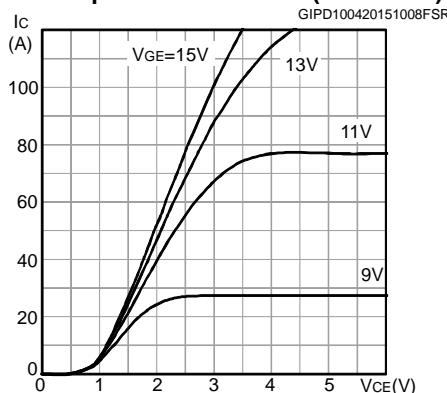
**Figure 2: Power dissipation vs. case temperature**



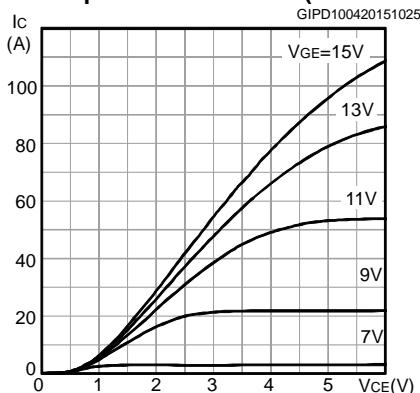
**Figure 3: Collector current vs. case temperature**



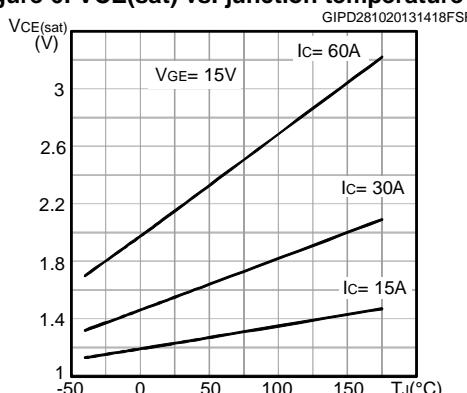
**Figure 4: Output characteristics ( $T_J = 25 \text{ °C}$ )**



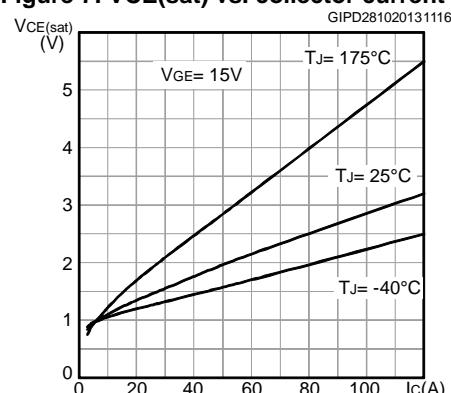
**Figure 5: Output characteristics ( $T_J = 175 \text{ °C}$ )**

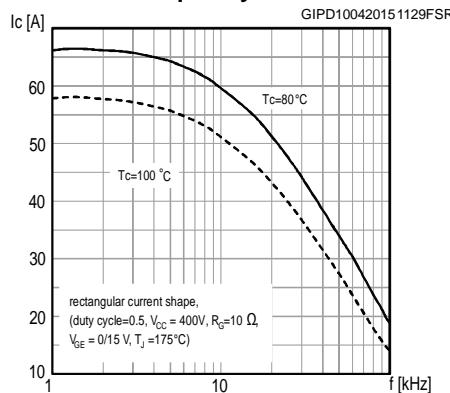
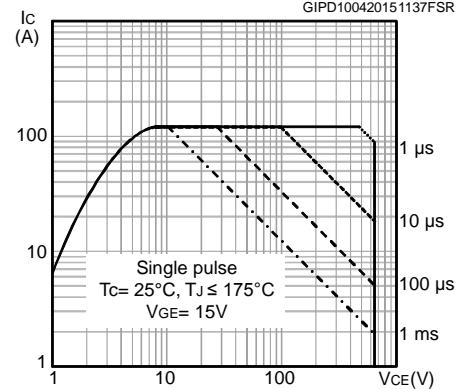
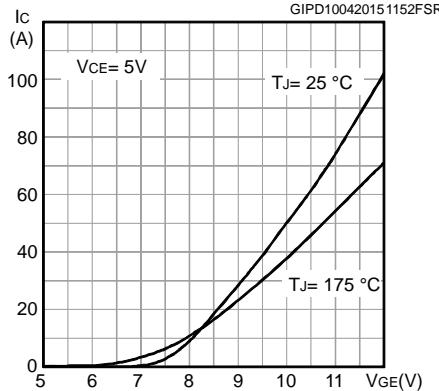
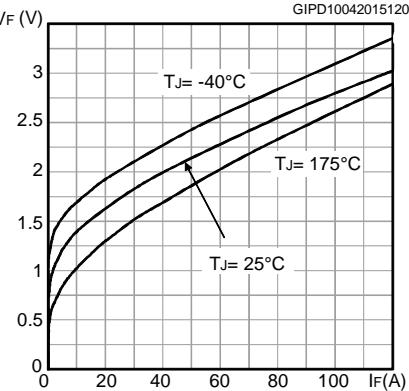
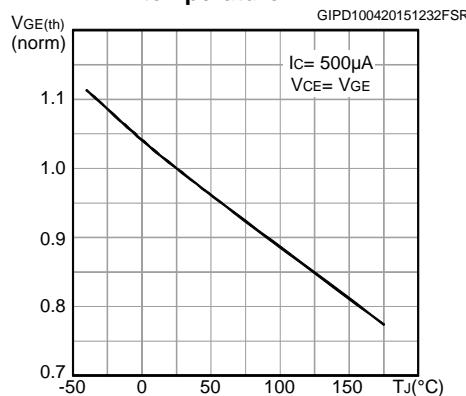
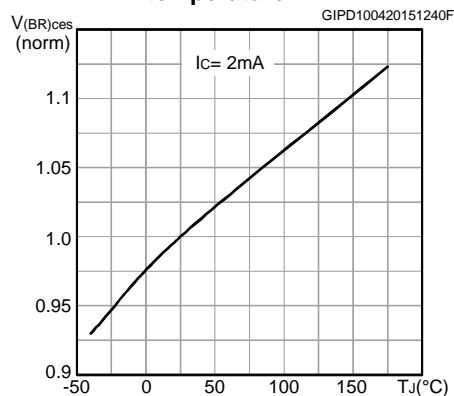


**Figure 6:  $V_{CE(sat)}$  vs. junction temperature**



**Figure 7:  $V_{CE(sat)}$  vs. collector current**

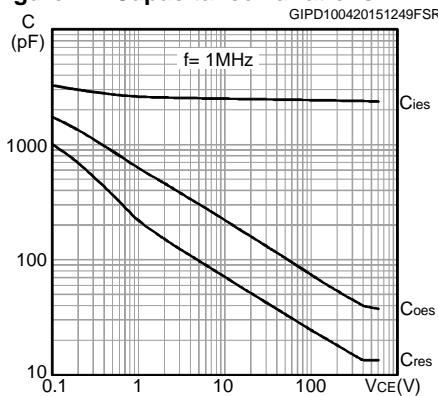


**Figure 8: Collector current vs. switching frequency****Figure 9: Forward bias safe operating area****Figure 10: Transfer characteristics****Figure 11: Diode VF vs. forward current****Figure 12: Normalized  $V_{GE(\text{th})}$  vs. junction temperature****Figure 13: Normalized  $V(BR)CES$  vs. junction temperature**

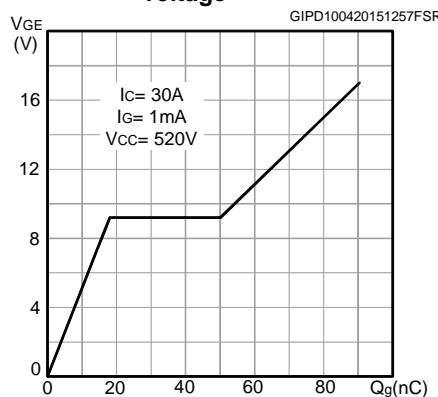
## Electrical characteristics

STGWA30M65DF2

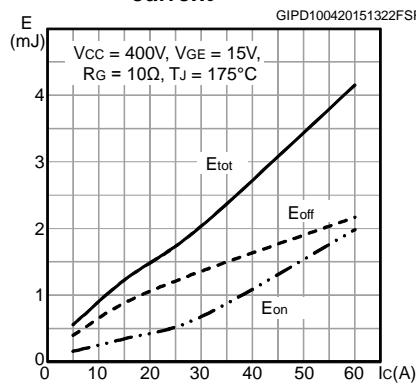
**Figure 14: Capacitance variations**



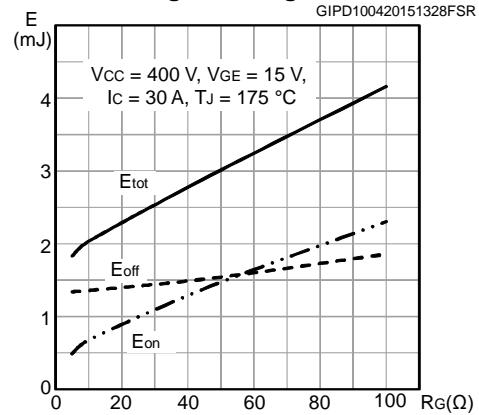
**Figure 15: Gate charge vs. gate-emitter voltage**



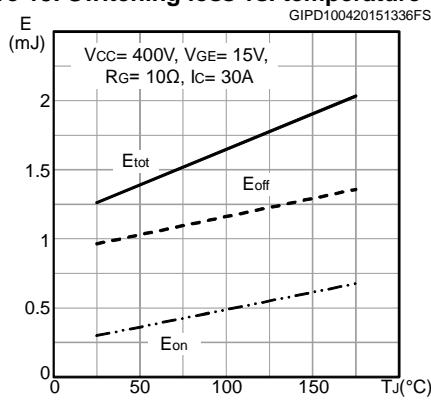
**Figure 16: Switching loss vs. collector current**



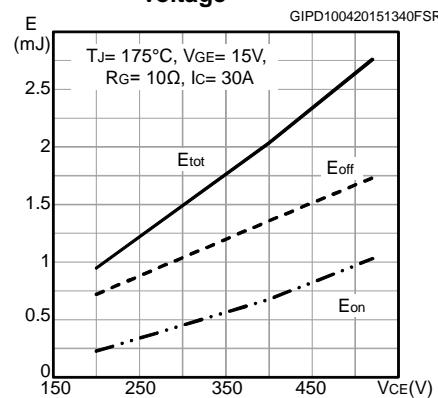
**Figure 17: Switching loss vs. gate resistance**



**Figure 18: Switching loss vs. temperature**



**Figure 19: Switching loss vs. collector emitter voltage**



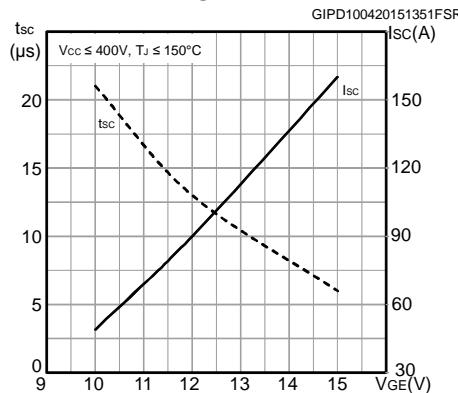
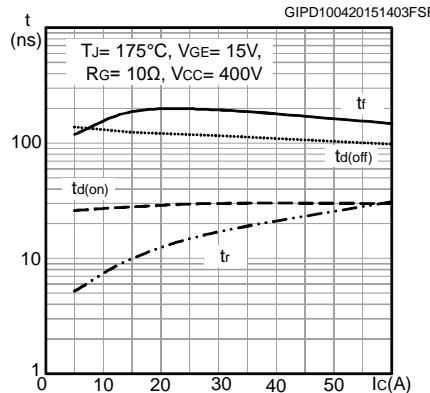
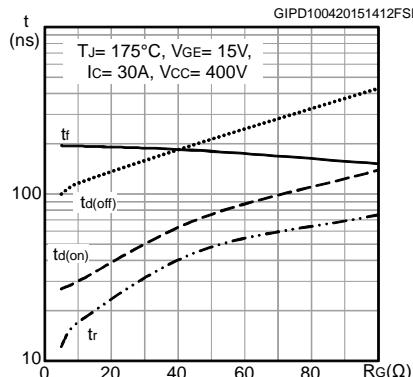
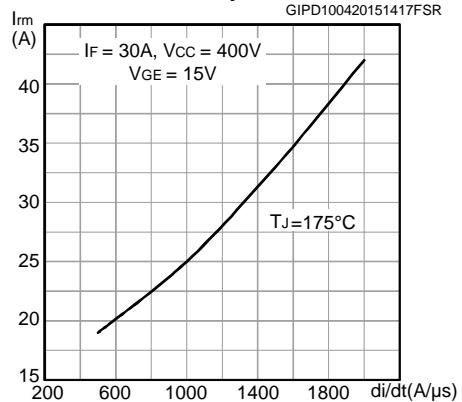
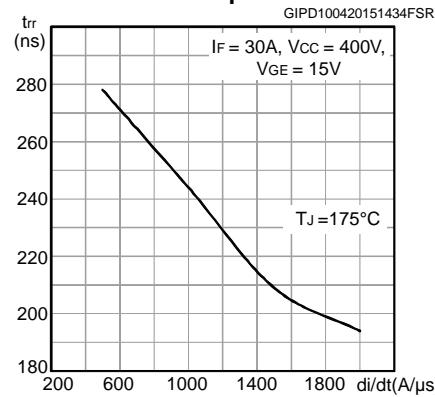
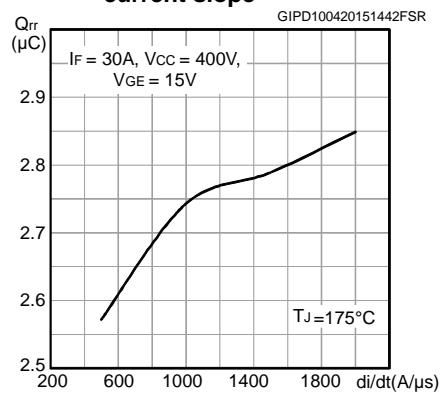
**Figure 20: Short-circuit time and current vs. VGE****Figure 21: Switching times vs. collector current****Figure 22: Switching times vs. gate resistance****Figure 23: Reverse recovery current vs. diode current slope****Figure 24: Reverse recovery time vs. diode current slope****Figure 25: Reverse recovery charge vs. diode current slope**

Figure 26: Reverse recovery energy vs. diode current slope

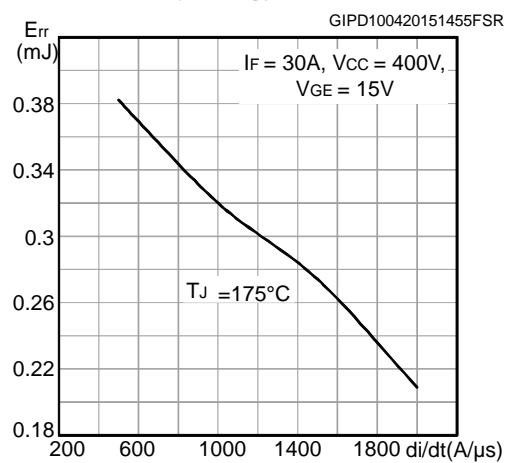


Figure 27: Thermal impedance for IGBT

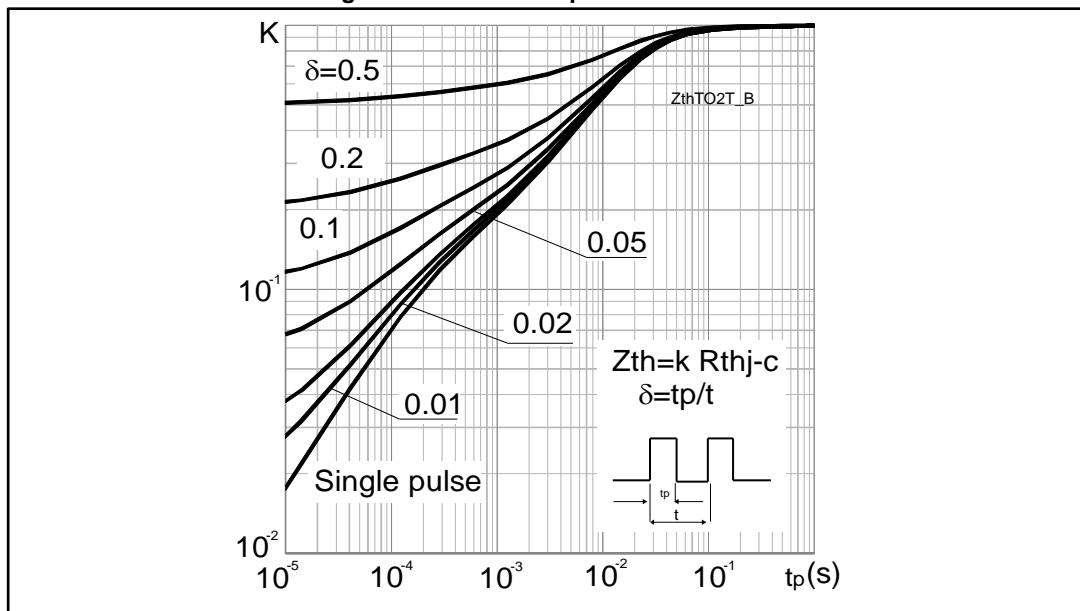
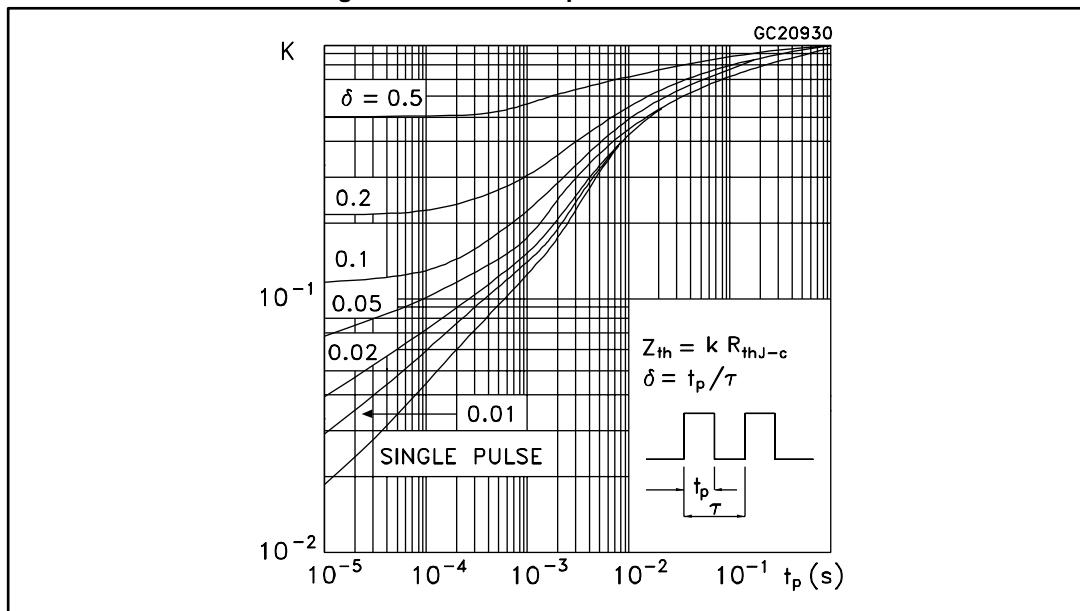
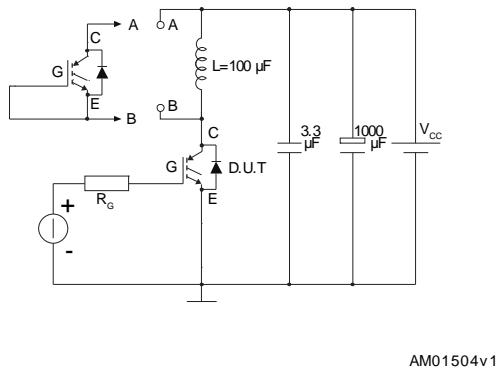


Figure 28: Thermal impedance for diode

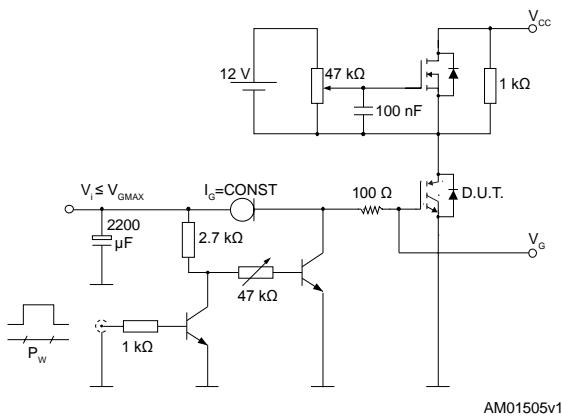


### 3 Test circuits

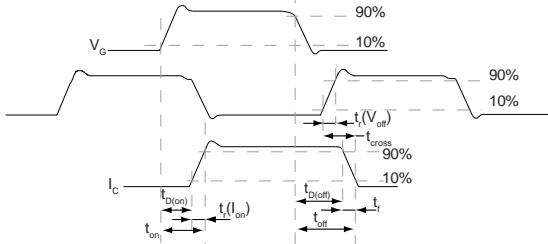
**Figure 29: Test circuit for inductive load switching**



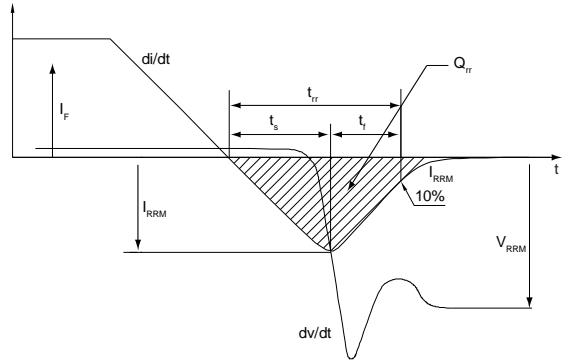
**Figure 30: Gate charge test circuit**



**Figure 31: Switching waveform**



**Figure 32: Diode reverse recovery waveform**



## 4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: [www.st.com](http://www.st.com).  
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### 4.1 Package mechanical data

Figure 33: TO-247 long leads package outline

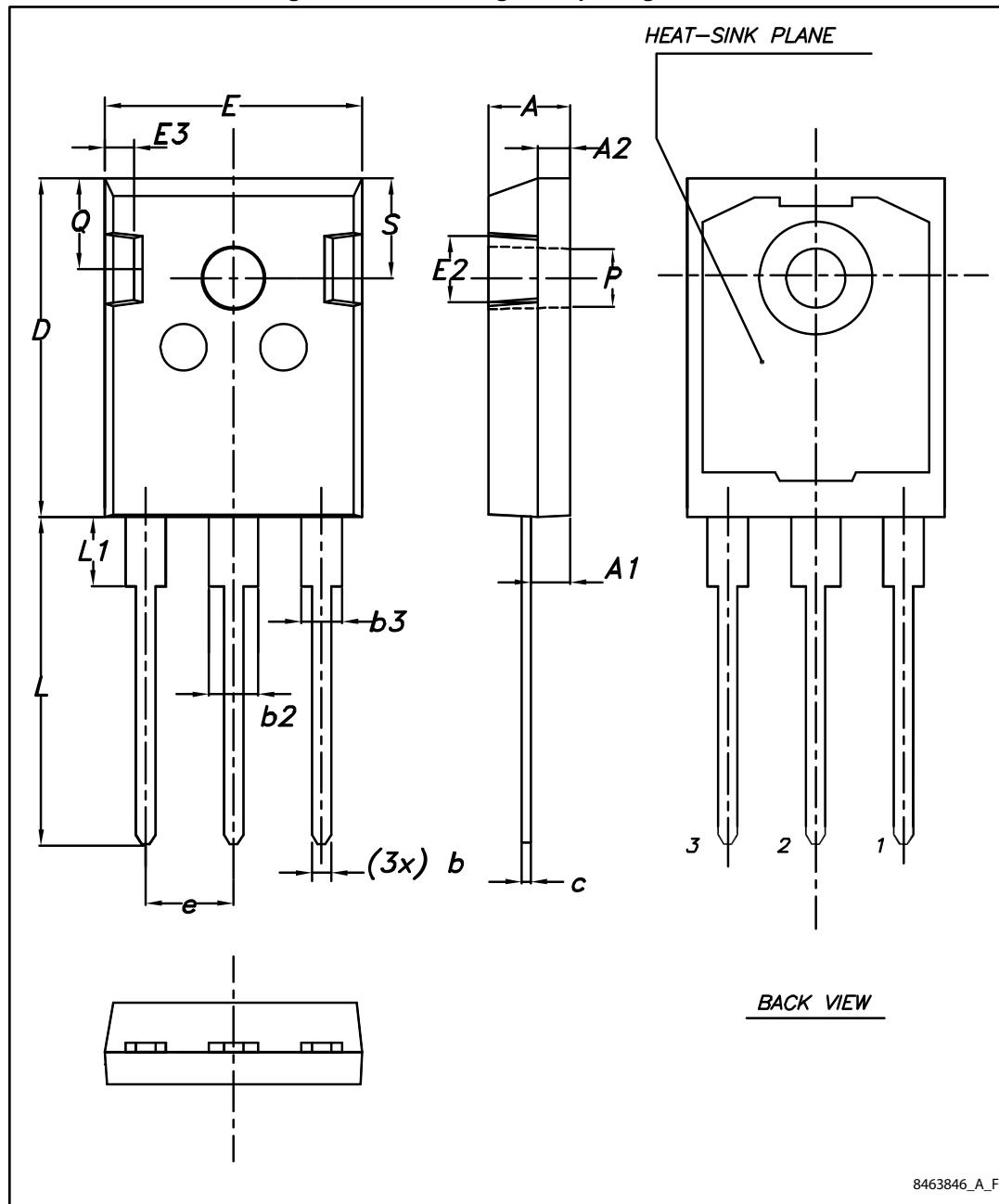


Table 8: TO-247 long leads package mechanical data

Dim.	mm.		
	Min.	Typ.	Max.
A	4.90	5.00	5.10
A1	2.31	2.41	2.51
A2	1.90	2.00	2.10
b	1.16		1.26
b2			3.25
b3			2.25
c	0.59		0.66
D	20.90	21.00	21.10
E	15.70	15.80	15.90
E2	4.90	5.00	5.10
E3	2.40	2.50	2.60
e	5.34	5.44	5.54
L	19.80	19.92	20.10
L1			4.30
P	3.50	3.60	3.70
Q	5.60		6.00
S	6.05	6.15	6.25

## 5 Revision history

Table 9: Document revision history

Date	Revision	Changes
04-May-2015	1	First release.

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